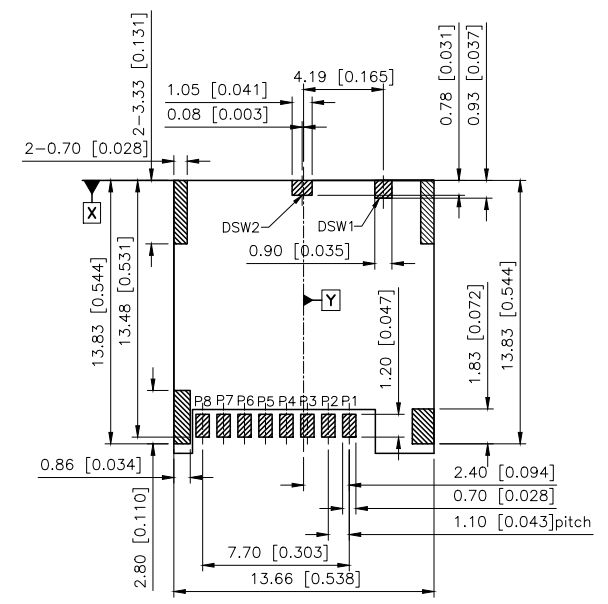
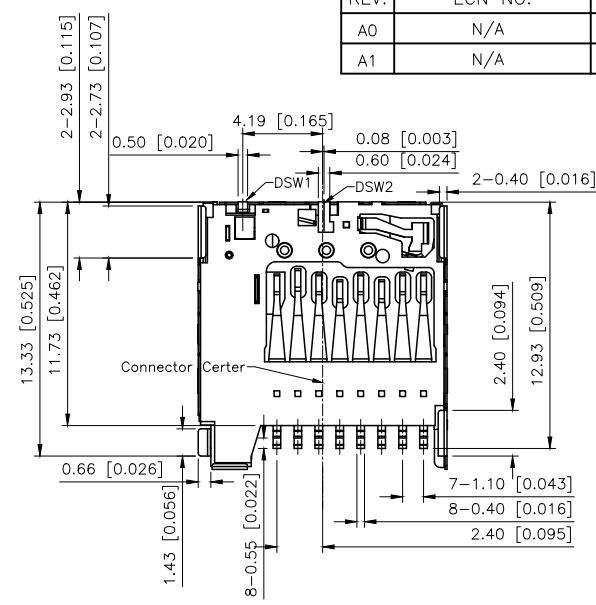
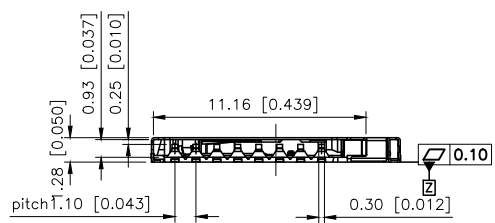
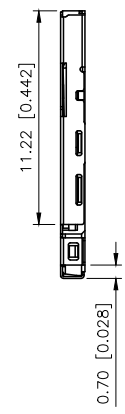
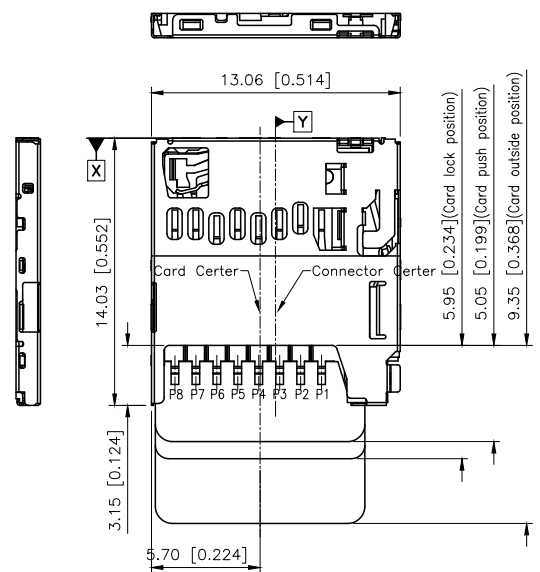
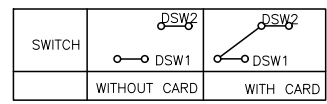


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.05.16	阿树

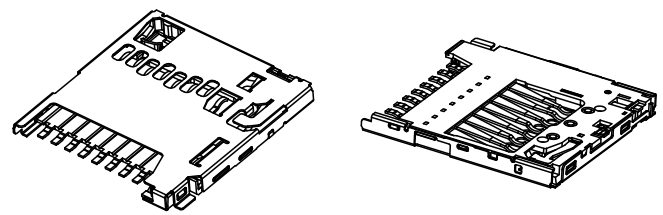


▨ PAD AREA
□ KEEP OUT AREA
▨ GND PATTERN ONLY

- 规格 Specification
- 1.材料 MATERIAL:
- 1.1 绝缘材料 Insulator:High Temperature Thermoplastic. LCP SZ6505HF black UL94V-0.
 - 1.2 端子 Terminal:Phosphor Bronze(C5210-H.T=0.15mm)
 - 1.3 外壳 Shell:SUS301-3/4H T=0.10mm
 - 1.4 弹簧 Spring: SUS301 L=9.80mm
 - 1.5 滑块 Slider: PPA black
 - 1.6 拉杆 Drawbar: SUS304-H.L=3.85mm
- 2.电镀 Plating:
- 2.1 端子 Terminal: Plated 80u'min Ni Overall
Plated 1u'min Au Selective contact area
Plated 1u'min Au over Ni on solder area
 - 2.2 外壳 Shell:Plated 1u'min Au overll 50u'min Ni
- 3.性能 Property:
- 3.1 额定电流 Current Rating :0.5A AC/DC max
 - 3.2 额定电压 Voltage Rating :12V AC/DC
 - 3.3 环境温度 Ambient Temperature Range :-20℃+60℃
 - 3.4 环境湿度 Ambient Humidity Range :95% R.H. Max.
 - 3.5 接触电阻 Contact Resistance:100mΩ max.
 - 3.6 绝缘电阻 Insulation Resistance:1000MΩ min/500VDC
 - 3.7 耐久性 Durability:5000 cycles



PIN NO.	PIN ASSIGNMENT
P1	DAT2
P2	CD/DAT3
P3	CMD
P4	VDD
P5	CLK
P6	VSS
P7	DAT0
P8	DAT1



AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:	MODEL TYPE: TF CARD CONN
CHECKED		UNIT: mm/in	PART NO.: XKTF-1151-2
APPROVED		SIZE: A4	DWG NO.: